

## Product Summary

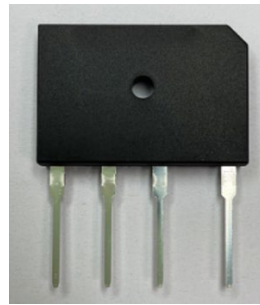
V <sub>RRM</sub> (V)	I <sub>F</sub> (A)	V <sub>F</sub> Max (V) @ I <sub>F</sub> = 17.5A	I <sub>R</sub> Max (μA)
600, 800	35	1.1	10

## Mechanical Data

- Case: GBJ
- Case Material: Plastic Material, UL Flammability Classification 94V-0
- Terminals: Finish – Matte Tin Plated Leads, Solderable Per MIL-STD-202, Method 208 Ⓜ3
- Component Is Accordance to RoHS 2002/95/EC
- Polarity Indicator: Symbol Molded on Body
- Weight: 6.60 grams (Approximate)

## Features

- Glass Passivated Die Construction
- Ideal for Printed Circuit Board
- High Surge Current Capability
- ESD Capability:
  - Machine Mode, C (>400V),
  - Human Body Model, 3B (> 8kV)
- UL Recognized File # E94661
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. “Green” Device (Note 3)**
- **For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](mailto:contact_us) or your local Diodes representative.**  
<https://www.diodes.com/quality/product-definitions/>

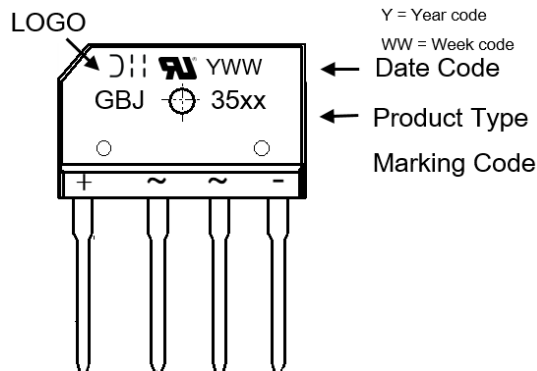


## Ordering Information (Note 4)

Part Number	Qualification	Case	Packaging
GBJ3506	Commercial	GBJ	15/Tube
GBJ3508	Commercial	GBJ	15/Tube

- Notes:
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
  2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

## Marking Information



**Maximum Ratings** (@ T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	GBJ3506	GBJ3508	Unit
Maximum Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	600	800	V
Average Rectified Output Current T <sub>C</sub> = +80°C	I <sub>F(AV)</sub>	With Heatsink		35
		Without Heatsink		3.6
Peak Forward Surge Current 8.3ms Single Half Sine Wave Superimposed On Rated Load T <sub>J</sub> = +25°C	I <sub>FSM</sub>			400
I <sup>2</sup> t Rating for Fusing (t = 8.3ms)	I <sup>2</sup> t			664
Mounting Torque (Recommended Torque: 0.5 N.m)	TOR			0.8
Operating Temperature Range	T <sub>J</sub>			-40 to +150
Storage Temperature Range	T <sub>STG</sub>			-55 to +150

**Electrical Characteristics**

Characteristic	Test Conditions	Symbol	Max	Unit
Forward Voltage	I <sub>F</sub> = 17.5A T <sub>J</sub> = +25°C	V <sub>F</sub>	1.1	V
Leakage Current	V <sub>R</sub> at Rated	I <sub>R</sub>	T <sub>J</sub> = +25°C	10
			T <sub>J</sub> = +125°C	500
Typical Junction Capacitance (Note 5)		C <sub>J</sub>	150	pF

**Thermal Characteristics**

Characteristic	Symbol	Typ.	Unit
Typical Thermal Resistance (Note 6)	R <sub>θJC</sub>	1.0	°C/W
	R <sub>θJL</sub>	1.5	

Notes: 5. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.  
6. Thermal resistance test performed in accordance with JESD-51. Device mounted on 250mm x 250mm x 25mm AL plate heatsink.

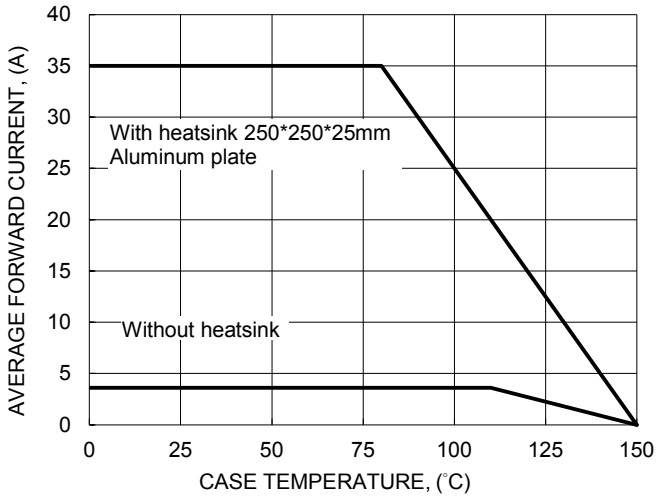


Figure 1. Forward Current Dearing Curve

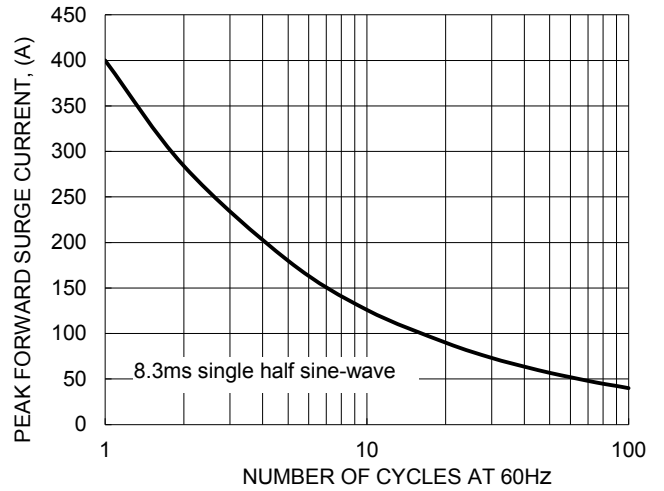


Figure 2. Maximum Non-repetitive Surge Current

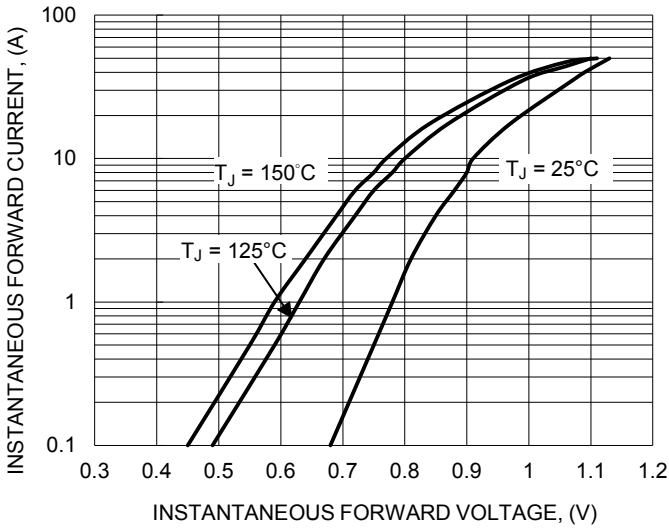


Figure 3. Typical Forward Characteristics

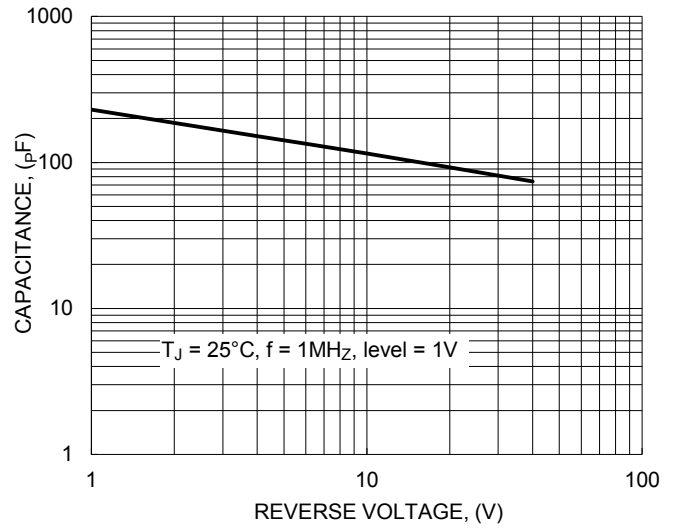


Figure 4. Typical Junction Capacitance

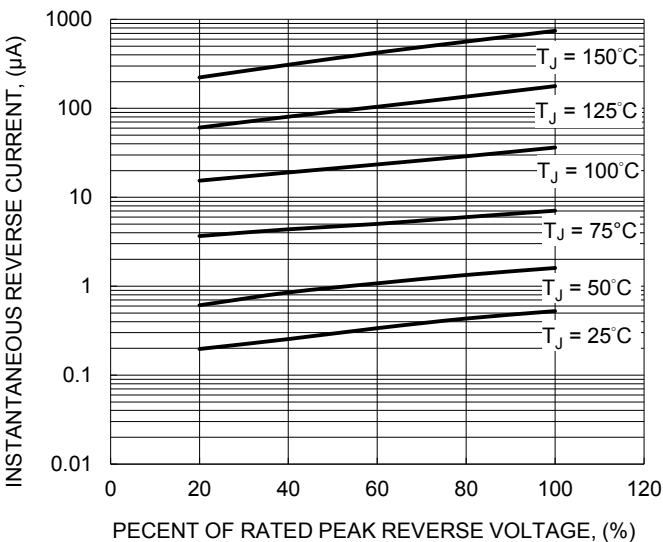


Figure 5. Typical Reverse Characteristics

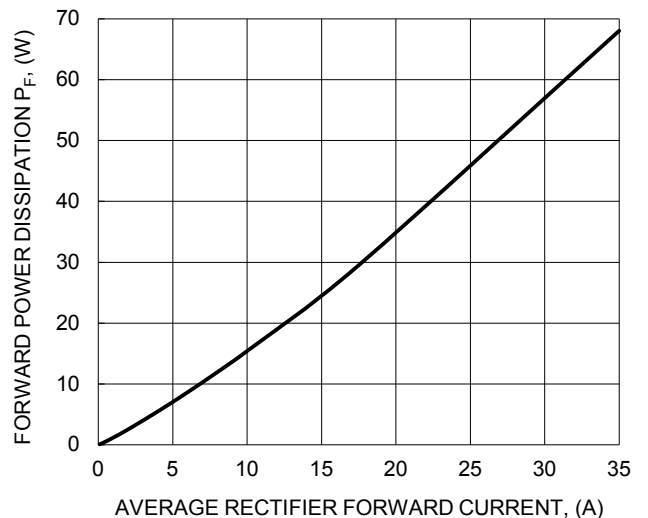
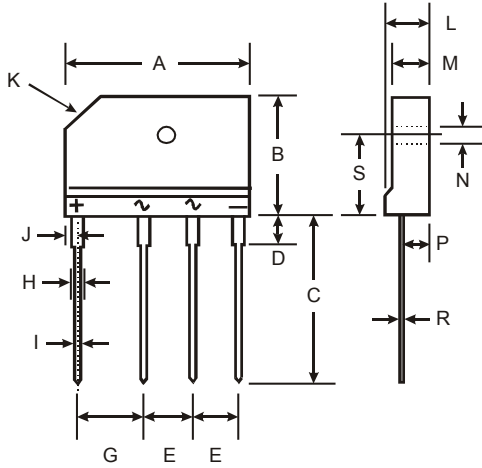


Figure 6. Forward Power Dissipation

**Package Outline Dimensions**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**GBJ**



GBJ		
Dim	Min	Max
A	29.70	30.30
B	19.70	20.30
C	17.00	18.00
D	3.80	4.20
E	7.30	7.70
G	9.80	10.20
H	2.00	2.40
I	0.90	1.10
J	2.30	2.70
K	3.0 X 45°	
L	4.40	4.80
M	3.40	3.80
N	3.10	3.40
P	2.50	2.90
R	0.60	0.80
S	10.80	11.20
All Dimensions in mm		

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